



THE DATASHEET OF MPC8245TVV350D



MPC8245 Hardware Specification Addendum for the MPC8245TXXnnnX Series

This document describes part-number-specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC8245 Integrated Processor Hardware Specifications* (Order No. MPC8245EC). The MPC8245 combines a PowerPC™ MPC603e core with a PCI bridge.

Specifications provided in this document supersede those in the *MPC8245 Integrated Processor Hardware Specifications*, Revision 7 or later, for the part numbers listed in [Table A](#) only. Specifications not addressed herein are unchanged. Because this document is frequently updated, refer to <http://www.freescale.com> or to a local Freescale sales office for the latest version.

Note that headings and table numbers in this document are not consecutively numbered. They correspond to the heading or table affected in the general hardware specification.

Part numbers addressed in this document are listed in [Table A](#). For more detailed ordering information, see [Section 9, “Ordering Information.”](#)

Freescale Part Numbers Affected:

MPC8245TVV266D

MPC8245TZU266D

MPC8245TVV300D

MPC8245TZU300D

MPC8245TVV333D

MPC8245TZU333D

MPC8245TVV350D

MPC8245TZU350D

Table A. Part Numbers Addressed by This Data Sheet

| Freescale Part Number | Operating Conditions | | | Significant Differences from Hardware Specification | Processor Version Register Value |
|----------------------------------|----------------------|-----------------|---------------------|---|----------------------------------|
| | CPU Frequency | V _{DD} | T _J (°C) | | |
| MPC8245TVV266D MPC8245TZU266D | 266 MHz | 1.7 V–2.1 V | –40 to 105 | Extended temperature range for additional part offering | 0x80811014 |
| MPC8245TVV300D MPC8245TZU300D | 300 MHz | | | | |
| MPC8245TVV333D MPC8245TZU333D | 333 MHz | 2.0 ± 100 mV | | | |
| MPC8245TVV350D MPC8245TZU350D | 350 MHz | | | | |

Note: The X prefix in a Freescale part number designates it as a ‘Pilot Production Prototype’ as defined by Freescale SOP 3-13. These are part of a limited production volume of prototypes manufactured, tested, and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes. Note that the VV package refers to lead free TBGA and is only available in part revision D.

4.1.3 DC Electrical Characteristics

Table 2 provides the recommended operating conditions for the MPC8245 part numbers described herein.

Table 2. Recommended Operating Conditions

| Characteristic | Symbol | Recommended Value | Unit |
|--------------------------|----------------|-------------------|------|
| Die-junction temperature | T _j | –40 to 105 | °C |

Note: These are the recommended and tested operating conditions. Proper device operation outside of these conditions is not guaranteed.

Please consult the *MPC8245 Integrated Processor Hardware Specifications* document for more details concerning the part’s specifications.

9 Ordering Information

Ordering information for the parts fully covered by this document is provided in [Section 9.1, “Part Numbers Fully Addressed by This Document.”](#) This section also addresses the marking specifications.

9.1 Part Numbers Fully Addressed by This Document

[Table 21](#) provides the ordering information for the MPC8245 parts described in this document. Note that the individual part numbers correspond to a maximum processor core frequency.

Table 21. Part Numbers Addressed by this document

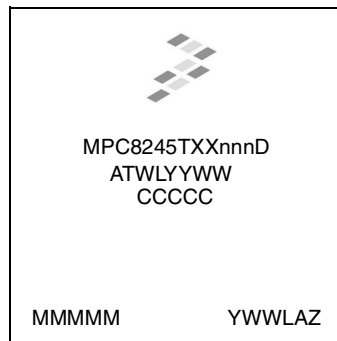
| MPC | nnnn | X | xx | nnn | X | |
|--------------|-----------------|--------------------|--|--|-------------------|----------------------------------|
| Product Code | Part Identifier | Process Descriptor | Package ¹ | Processor Frequency ² | Revision Level | Processor Version Register Value |
| MPC | 8245 | T: -40° to 105°C | ZU = TBGA V V ³ = Lead-free TBGA | 266 MHz, 300 MHz: 1.7 V to 2.1 V 333 MHz, 350 MHz: 1.9 V to 2.2 V | D:1.4 Rev ID:0x14 | 0x80811014 |

Notes:

1. See [Section 5, “Package Description,”](#) in the *MPC8245 Integrated Processor Hardware Specifications* for more information on available package types.
2. Processor core frequencies supported by parts addressed by this specification only. Not all parts described in this specification support all core frequencies. Additionally, parts addressed by part number specifications may support other maximum core frequencies.
3. Note that the V V package option is only available in part revision D.

9.3 Part Marking

Parts are marked as in the example shown in [Figure 33](#).

Figure 33. Freescale Part Marking for TBGA Device

Notes:

- MMMMM is the 5-digit mask number.
- ATWLYYWW is Test traceability code.
- YWWLAZ is the Assembly traceability code.
- CCCCC is the country code.

Document Revision History

Table B provides a revision history for this part number specification.

Table B. Document Revision History

| Revision | Date | Substantive Change(s) |
|----------|----------|---|
| 1.1 | 12/2005 | Changed all occurrences of XPC to MPC. Table 21 and Figure 33 were updated to reflect current part nomenclature and marking. |
| 1 | 10/05/04 | Added range information regarding 1.7V to 2.1V for 266 MHz and 300 MHz parts. Changed title wording from 'Part Number Specification' to 'Hardware Specification Addendum'; adopted new Document ID numbering scheme. This document replaces the earlier document MPC8245TXXPNS. |
| 0 | 03/14/04 | Original version of MPC8245TXXPNS. Information in this document supersedes that of the MPC8245TZUPNS as lead free (Vv) information was added. |

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Document Number: MPC8245ECS01AD
Rev. 1.1
12/2005

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